V_{RM} = 300 V, $I_{F(AV)}$ = 20 A, t_{rr} = 30 ns
Fast Recovery Diode

FMX-4203S

Data Sheet

Description

The FMX-4203S is a fast recovery diode of 300 V / 20 A. The maximum t_{rr} of 30 ns is realized by optimizing a life-time control.

Features

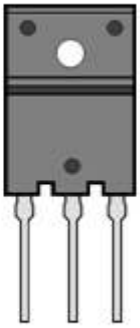
- V_{RSM} ---------- 300 V
- $I_{F(AV)}$ ---------- 20 A
- V_F ---------- 0.97 V
- t_{rr1} (I_F = I_{RP}) ---------- 30 ns
- Bare Lead Frame: Pb-free (RoHS Compliant)
- Flammability: Equivalent to UL94V-0

Applications

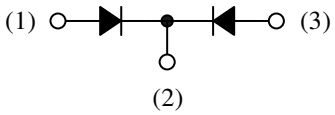
- Secondary-side Rectifier Diode
  (Flyback Converter, LLC Converter, etc.)
- Freewheel Diode
  (Offline Buck Converter, Offline Buck-boost Converter, etc.)

Package

TO3PF-3L



Not to scale



(1) Anode
(2) Cathode
(3) Anode

Absolute Maximum Ratings

Unless otherwise specified, T_A = 25 °C.

Parameter	Symbol	Conditions	Rating	Unit
Nonrepetitive Peak Reverse Voltage	V_{RSM}		300	V
Repetitive Peak Reverse Voltage	V_{RM}		300	V
Average Forward Current	$I_{F(AV)}$	See Figure 1 and Figure 2	20	A
Surge Forward Current	I_{FSM}	Half cycle sine wave, positive side, 10 ms, 1 shot	100	A
I^2t Limiting Value	I^2t	1 ms ≤ t ≤ 10 ms	50	A^2s
Junction Temperature	T_J		−40 to 150	°C
Storage Temperature	T_{STG}		−40 to 150	°C

Electrical Characteristics

Unless otherwise specified, T_A = 25 °C.

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage Drop[1]	V_F	I_F = 10 A	—	0.97	1.30	V
Reverse Leakage Current[1]	I_R	$V_R = V_{RM}$	—	—	100	μA
Reverse Leakage Current under High Temperature[1]	$H \cdot I_R$	$V_R = V_{RM}$, T_J = 150 °C	—	—	30	mA
Reverse Recovery Time[1]	t_{rr1}	$I_F = I_{RP}$ = 500 mA, 90% recovery point, T_J = 25 °C	—	—	30	ns
	t_{rr2}	I_F = 500 mA, I_{RP} = 1000 mA, 75% recovery point, T_J = 25 °C	—	—	25	ns
Thermal Resistance[2]	$R_{th(J-C)}$		—	—	2.0	°C/W

Mechanical Characteristics

Parameter	Conditions	Min.	Typ.	Max.	Unit
Heatsink Mounting Screw Torque		0.686	—	0.882	N·m
Package Weight		—	6.5	—	g

[1] The rating of one chip.

[2] $R_{th\ (J-C)}$ is thermal resistance between junction and the case. The case temperature is measured at the back side near the screw hole.

Rating and Characteristic Curves

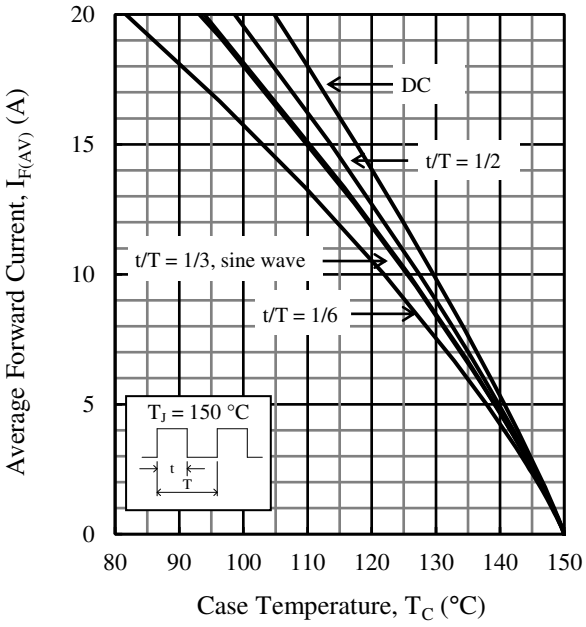


Figure 1. Typical Characteristics: $I_{F(AV)}$ vs. T_C (V_R = 0 V)

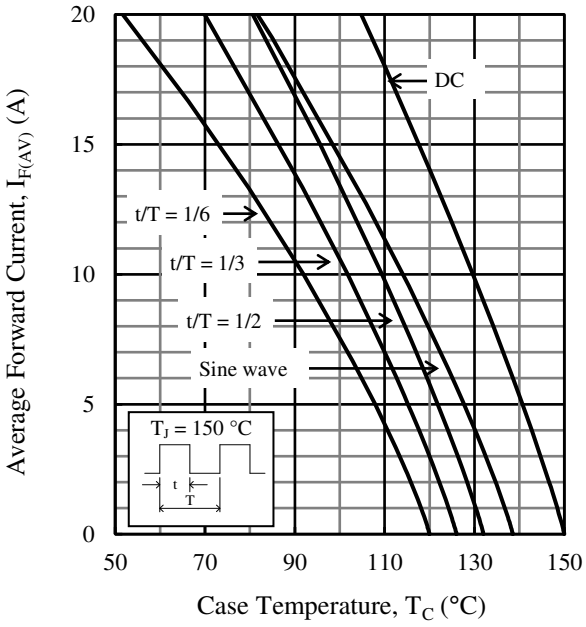


Figure 2. Typical Characteristics: $I_{F(AV)}$ vs. T_C (V_R = 300 V)

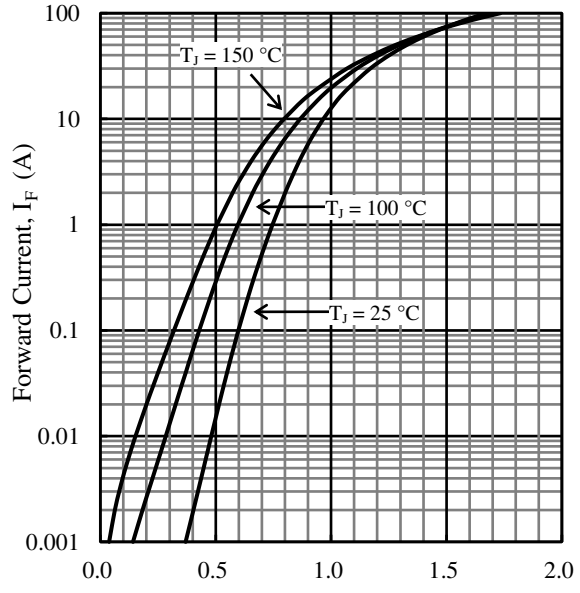


Figure 3. Typical Characteristics: I_F vs. V_F

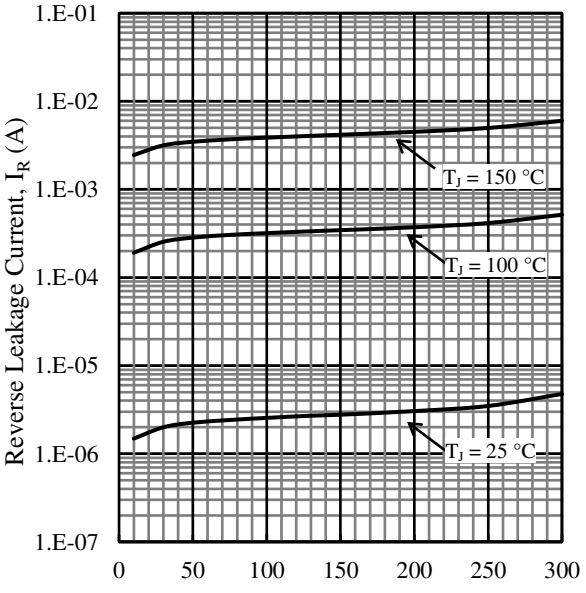
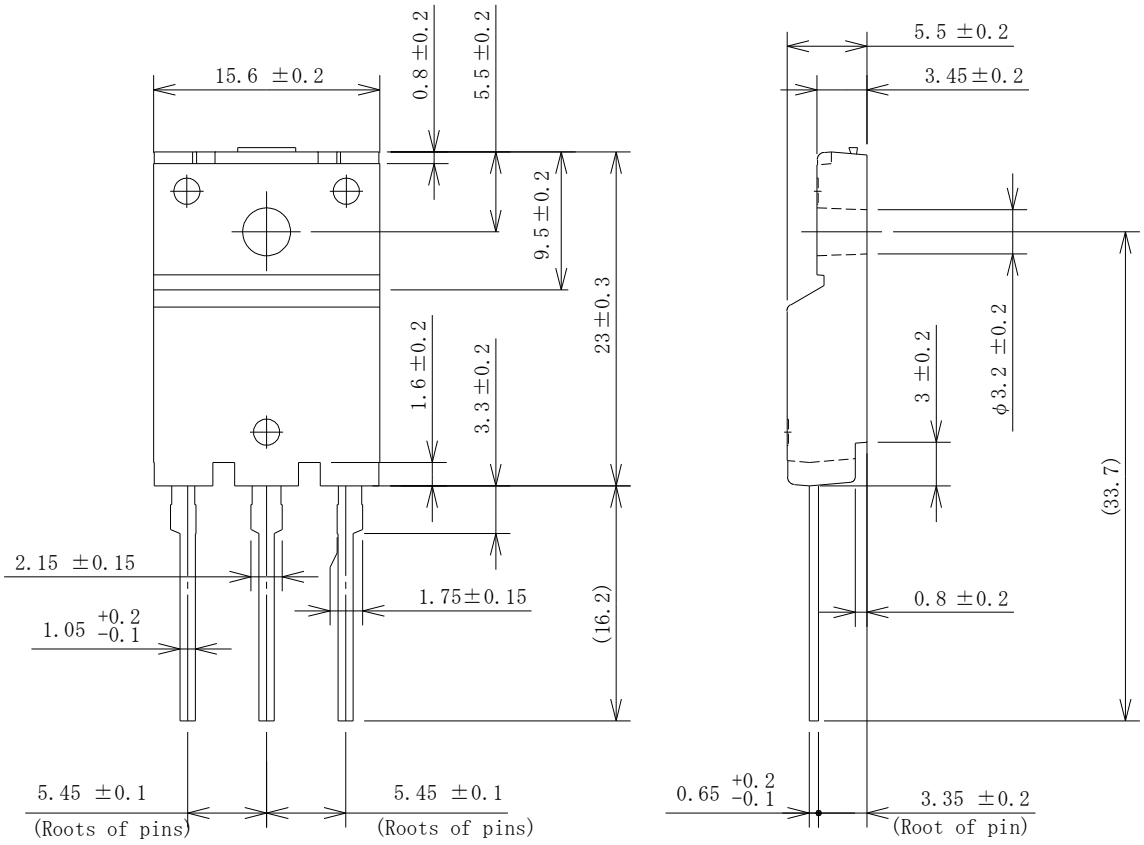
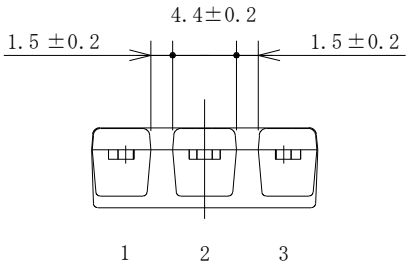


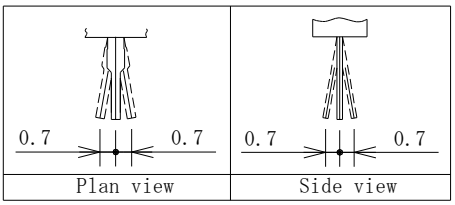
Figure 4. Typical Characteristics: I_R vs. V_R

Physical Dimensions

● **TO3PF-3L**



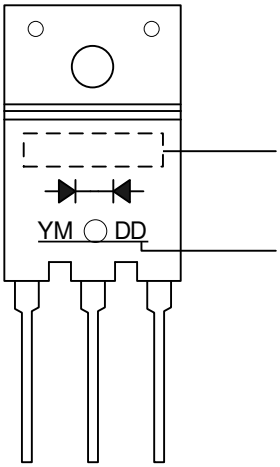




NOTES:

- Dimensions in millimeters
- Maximum gate burr height is 0.3 mm.
- Bare lead frame: Pb-free (RoHS compliant)
- When soldering the products, it is required to minimize the working time within the following limits:
  Flow: 260 °C / 10 s, 1 time
  Soldering Iron: 350 °C / 3.5 s, 1 time
  Soldering should be at a distance of at least 1.5 mm from the body of the product.

Marking Diagram



Specific Device Code (See Table 1)

Lot Number:
Y is the last digit of the year of manufacture (0 to 9)
M is the month of the year (1 to 9, O, N, or D)
DD is the day of the month (01 to 31)

Table 1. Specific Device Code

Specific Device Code	Part Number
X4203S	FMX-4203S

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